



PRODUCT BULLETIN
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13 Jun 2008

SUBJECT: ON Semiconductor Product Bulletin #PB16125

TITLE: 40 pin QFN (7 x 7 x 1mm) MSL upgrade

PROPOSED FIRST SHIP DATE: 13 Jun 2008

AFFECTED PRODUCT DIVISION: Computing Products Group

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor sales office or Rob Swanson <Rob.Swanson@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact your local ON Semiconductor sales office.

DESCRIPTION AND PURPOSE:

Due to recent Scanning Acoustic Tomography (SAT) testing, the Moisture Sensitivity Level (MSL) rating has been upgraded from MSL-3 to MSL-1 at 260C solder reflow temperature. Thus, dry-packing is no longer required for shipments, effective immediately.

AFFECTED DEVICE LIST

NCP5381AMNR2G
NCP5381MNR2G
NCP5388MNR2G
NCP5385MNR2G